



瑞晶電子股份有限公司  
Rexchip Electronics Corp.

### **Rexchip Announces Successful Pilot Run of Elpida's 40nm 2Gb DDR3**

---

**Houli, Taiwan, August 12, 2010** – Rexchip Electronics Inc. (4932) today, announced it has successfully completed pilot run of Elpida's 40nm 2Gb DDR3 product. Pilot run results for Elpida's 40nm process have met expectations and 100% migration remains on schedule.

Rexchip President and Spokesmen Mr. Stephen Chen, stated that currently Rexchip has already two immersion scanners successfully installed and expects to have the remaining tools installed before November of this year. This will allow Rexchip to maintain its original plan of complete migration to Elpida's 40nm process by the end of the year with a monthly capacity of 80,000 wafers producing the mainstream product 2Gb DDR3.

Elpida President and CEO Mr. Yukio Sakamoto stated, for this achievement of a successful pilot run of 40nm, we are very pleased and would like to thank all of Rexchip's employees for their hard work, your outstanding efforts and teamwork was key to this success and is worthy of celebration.

Rexchip is a leading DRAM manufacturer located in Central Taiwan Science Park. Rexchip possesses an advanced 12" fab (Fab R1) which currently besides, manufacturing 80,000 wafers per month utilizing Elpida's 65nm-XS process, is focusing on 40nm process migration in order to provide high-quality and high-efficiency DRAM products to maintain its leadership and competitiveness.

Contact : Sandy Kuo (886-4-25218000 ext. 8091)